PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	ASSIGNMENT		

CONVEYING PARTY DATA

Name	Execution Date	
Chih-Ming Chen	06/24/2013	
Szu-Yu Wang	06/21/2013	
Chung-Yi Yu	06/21/2013	

RECEIVING PARTY DATA

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City:	Hsin-Chu		
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Postal Code:	300-77		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13925940

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NAME OF SUBMITTER:	Thomas G. Eschweiler
Signature:	/Thomas G. Eschweiler/

502396553 REEL: 030677 FRAME: 0449

IOP \$40,00 13925940

Date:	06/25/2013
Total Attachments: 5 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif source=Assignment#page4.tif source=Assignment#page5.tif	

U.S. Patent Appln. No. Filing Date

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

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Assignor(s):

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Assignee:

Taiwan Semiconductor Manufacturing Co., Ltd. No. 8, Li-Hsin Rd. 6, Hsin-Chu Science Park Hsin-Chu, Taiwan 300-77 Republic of China

<u>AGREEMENT</u>

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled

"INTEGRATED CIRCUIT WITH BACKSIDE STRUCTURES TO REDUCE **SUBSTRATE WRAP"** for which:

a non-provisional application for United States Letters Patent:

\boxtimes	was executed on even date preparatory to filing (each inventor should sign this
	Assignment on the same day as he/she signs the Declaration and Power of
•	Attorney); or
	was filed on and accorded U.S. Serial No; or

TSMC Docket No. TSMC2013-0344

Docket No. TSMCP284US

U.S. Patent Appln. No. Filing Date

Ш	I hereby authori	ze and	request m	y attornèy	associated	with Cu	ıstomer	No.
	107476, to insert	t on the	designated	l lines belo	w the filing	date and	l applica	ation
	number of said application when known:							
	U.S. Serial No.				1			
	filed on		-					

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNOR(S) agree to execute all

TSMC Docket No. TSMC2013-0344

Docket No. TSMCP284US

Filing Date

U.S. Patent Appln. No.

instruments and documents required for the making and prosecution of applications for

United States and foreign letters patent on said invention, for litigation regarding said letters

patent, or for the purpose of protecting title to said invention or letters patent therefore.

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TSMC Docket No. TSMC2013-0344 Docket No. TSMCP284US

U.S. Patent Appln. No. Filing Date

Name

PATENT

REEL: 030677 FRAME: 0454

TSMC Docket No. TSMC2013-0344

Docket No. TSMCP284US

U.S. Patent Appln. No. Filing Date

6/21, 2013

RECORDED: 06/25/2013

Name 3rd Inventor C

Page 5 of 5